

**N-Channel Enhancement Mode Power MOSFET****Description**

The GT095N10KA uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge. It can be used in a wide variety of applications.

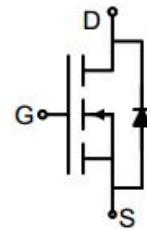
AEC-Q101 Qualified

**General Features**

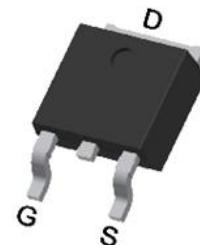
- $V_{DS}$  100V
- $I_D$  (at  $V_{GS} = 10V$ ) 63A
- $R_{DS(ON)}$  (at  $V_{GS} = 10V$ ) < 10.5mΩ
- $R_{DS(ON)}$  (at  $V_{GS} = 4.5V$ ) < 15mΩ
- 100% Avalanche Tested
- RoHS Compliant

**Application**

- Power switch
- DC/DC converters



Schematic diagram



TO-252

**Ordering Information**

| Device     | Package | Marking  | Packaging    |
|------------|---------|----------|--------------|
| GT095N10KA | TO-252  | GT095N10 | 2500pcs/Reel |

**Absolute Maximum Ratings**  $T_C = 25^\circ\text{C}$ , unless otherwise noted

| Parameter  | Symbol         | Value      | Unit |
|--|----------------|------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | 100        | V    |
| Continuous Drain Current                         | $I_D$          | 63         | A    |
| $T_C = 100^\circ\text{C}$                        |                | 40         |      |
| Pulsed Drain Current<br>(note1)                  | $I_{DM}$       | 252        | A    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$   | V    |
| Power Dissipation                                | $P_D$          | 80         | W    |
| Single pulse avalanche energy<br>(note2)         | $E_{AS}$       | 73         | mJ   |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$ | -55 To 150 | °C   |

**Thermal Resistance**

| Parameter                               | Symbol     | Value | Unit |
|---|------------|-------|------|
| Thermal Resistance, Junction-to-Ambient | $R_{thJA}$ | 50    | °C/W |
| Thermal Resistance, Junction-to-Case    | $R_{thJC}$ | 1.56  | °C/W |

**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

| Parameter                                      | Symbol                      | Test Conditions   | Value |      |           | Unit             |
|--|-----------------------------|---|-------|------|-----------|------------------|
|  |                             |   | Min.  | Typ. | Max.      |                  |
| <b>Static Parameters</b>                       |                             |   |       |      |           |                  |
| Drain-Source Breakdown Voltage                 | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$                               | 100   | --   | --        | V                |
| Zero Gate Voltage Drain Current                | $I_{\text{DSS}}$            | $V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$                        | --    | --   | 1         | $\mu\text{A}$    |
| Gate-Source Leakage                            | $I_{\text{GSS}}$            | $V_{\text{GS}} = \pm 20\text{V}$  | --    | --   | $\pm 100$ | nA               |
| Gate-Source Threshold Voltage                  | $V_{\text{GS}(\text{th})}$  | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$                           | 1.0   | 1.8  | 2.5       | V                |
| Drain-Source On-Resistance                     | $R_{\text{DS}(\text{on})}$  | $V_{\text{GS}} = 10\text{V}, I_D = 35\text{A}$                                  | --    | 8.5  | 10.5      | $\text{m}\Omega$ |
|  |                             | $V_{\text{GS}} = 4.5\text{V}, I_D = 35\text{A}$                                 | --    | 10.5 | 15        |                  |
| Forward Transconductance                       | $g_{\text{FS}}$             | $V_{\text{GS}} = 5\text{V}, I_D = 35\text{A}$                                   | --    | 70   | --        | S                |
| <b>Dynamic Parameters</b>                      |                             |   |       |      |           |                  |
| Input Capacitance                              | $C_{\text{iss}}$            | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 50\text{V}, f = 1.0\text{MHz}$      | --    | 1600 | --        | $\text{pF}$      |
| Output Capacitance                             | $C_{\text{oss}}$            |   | --    | 650  | --        |                  |
| Reverse Transfer Capacitance                   | $C_{\text{rss}}$            |   | --    | 8    | --        |                  |
| Total Gate Charge                              | $Q_g$                       | $V_{\text{DD}} = 50\text{V}, I_D = 35\text{A}, V_{\text{GS}} = 10\text{V}$      | --    | 33   | --        | $\text{nC}$      |
| Gate-Source Charge                             | $Q_{\text{gs}}$             |   | --    | 5    | --        |                  |
| Gate-Drain Charge                              | $Q_{\text{gd}}$             |   | --    | 8    | --        |                  |
| Turn-on Delay Time                             | $t_{\text{d}(\text{on})}$   | $V_{\text{DD}} = 50\text{V}, I_D = 35\text{A}, R_G = 1.6\Omega$                 | --    | 13   | --        | $\text{ns}$      |
| Turn-on Rise Time                              | $t_r$                       |   | --    | 10   | --        |                  |
| Turn-off Delay Time                            | $t_{\text{d}(\text{off})}$  |   | --    | 30   | --        |                  |
| Turn-off Fall Time                             | $t_f$                       |   | --    | 8    | --        |                  |
| <b>Drain-Source Body Diode Characteristics</b> |                             |   |       |      |           |                  |
| Continuous Body Diode Current                  | $I_S$                       | $T_C = 25^\circ\text{C}$  | --    | --   | 63        | A                |
| Body Diode Voltage                             | $V_{\text{SD}}$             | $T_J = 25^\circ\text{C}, I_{\text{SD}} = 35\text{A}, V_{\text{GS}} = 0\text{V}$ | --    | --   | 1.2       | V                |
| Reverse Recovery Charge                        | $Q_{\text{rr}}$             | $I_F = 35\text{A}, V_{\text{GS}} = 0\text{V}$<br>$dI/dt = 500\text{A/us}$       | --    | 95   | --        | $\text{nC}$      |
| Reverse Recovery Time                          | $T_{\text{rr}}$             |   | --    | 45   | --        | ns               |

**Notes**

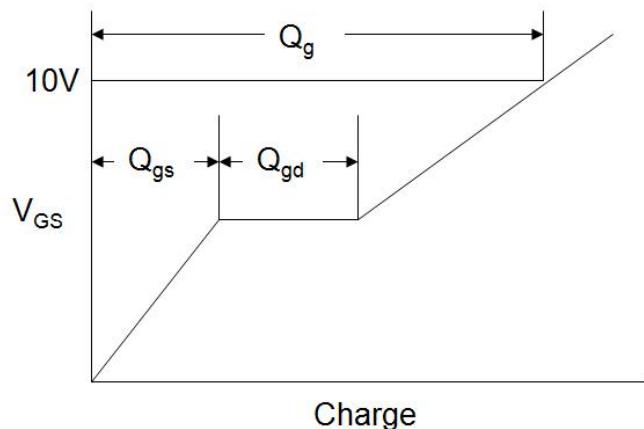
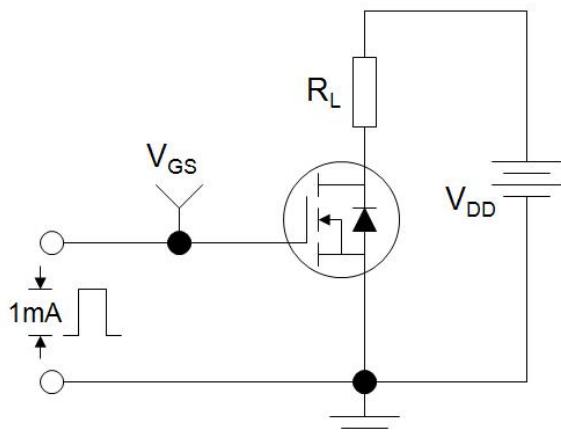
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. EAS condition :  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=50\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_G=25\Omega$

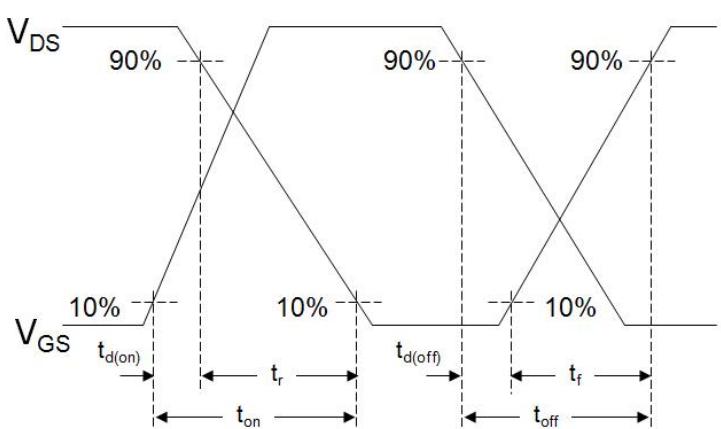
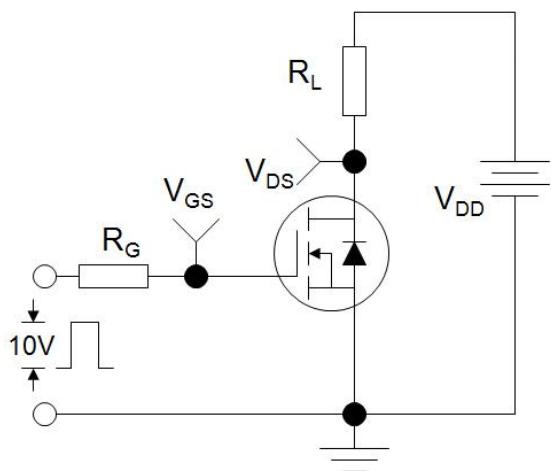
The table shows the minimum avalanche energy, which is 196mJ when the device is tested until failure

3. Identical low side and high side switch with identical  $R_G$

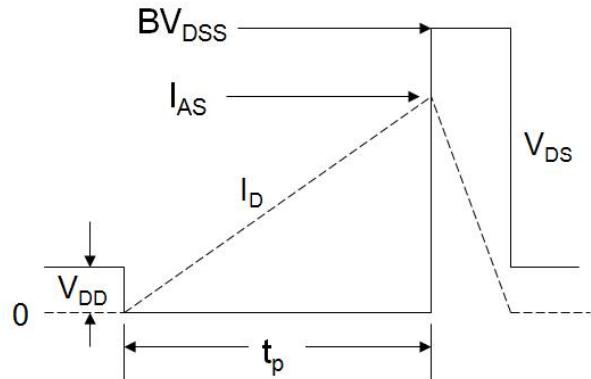
### Gate Charge Test Circuit



### Switch Time Test Circuit

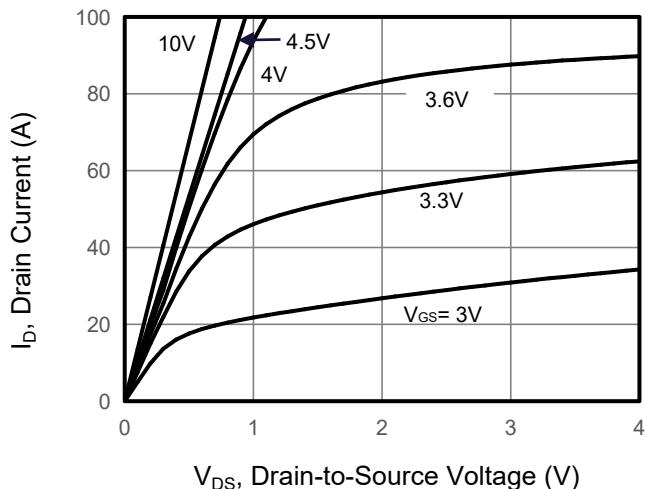


### EAS Test Circuit

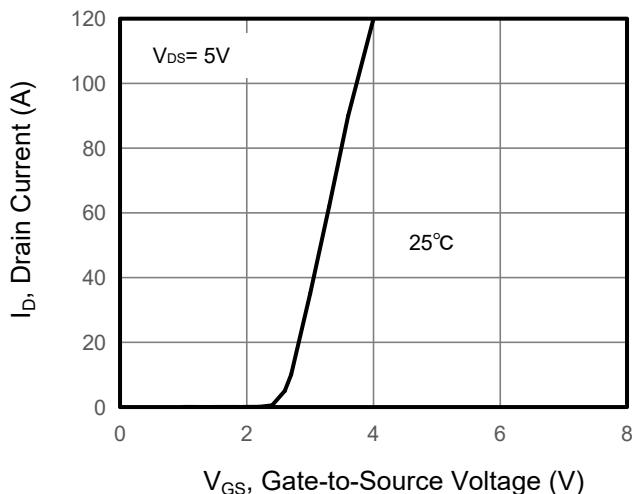


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

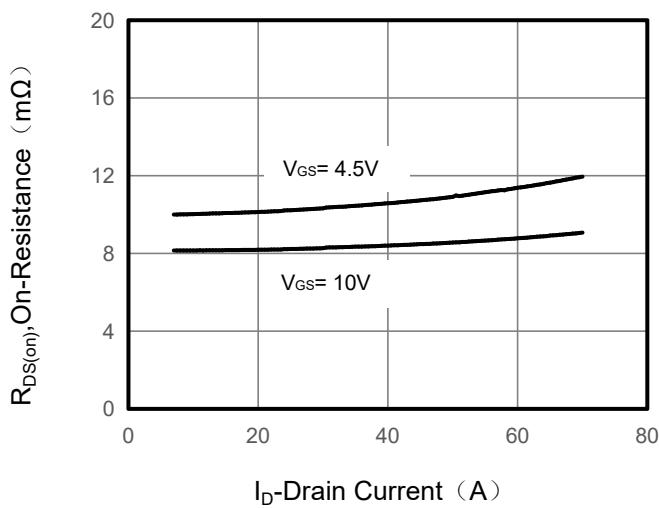
**Figure 1. Output Characteristics**



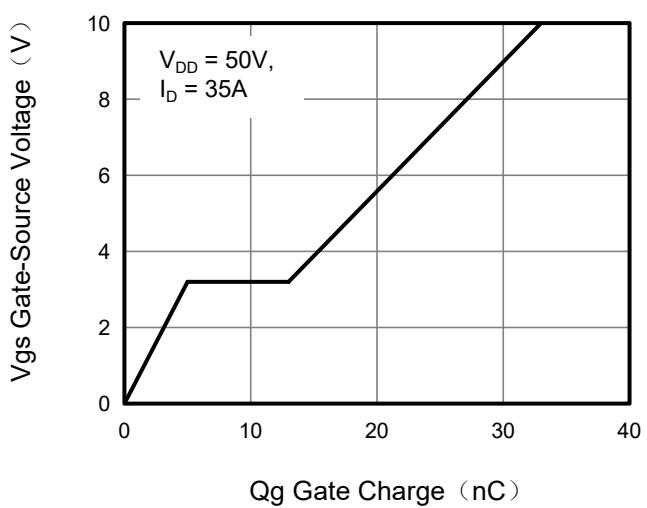
**Figure 2. Transfer Characteristics**



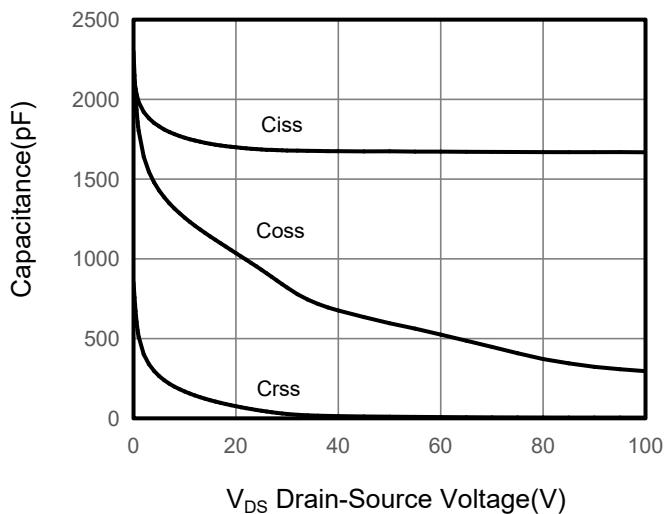
**Figure 3. Drain Source On Resistance**



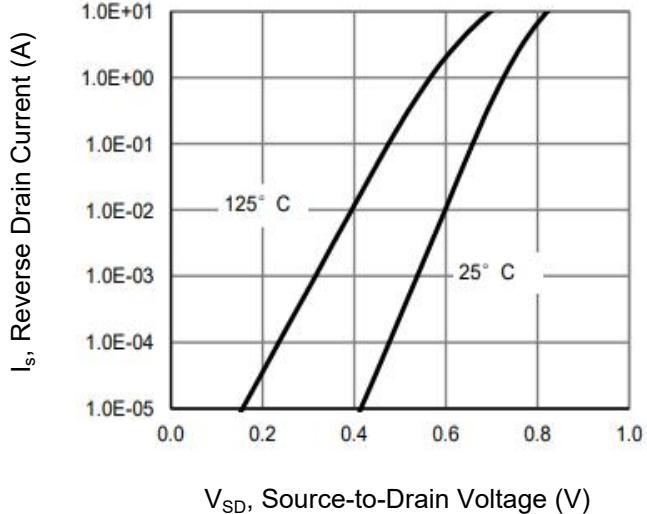
**Figure 4. Gate Charge**



**Figure 5. Capacitance**

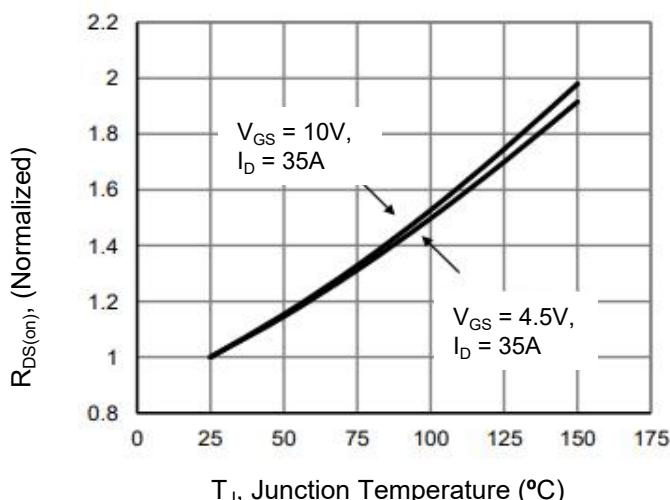


**Figure 6. Source-Drain Diode Forward**

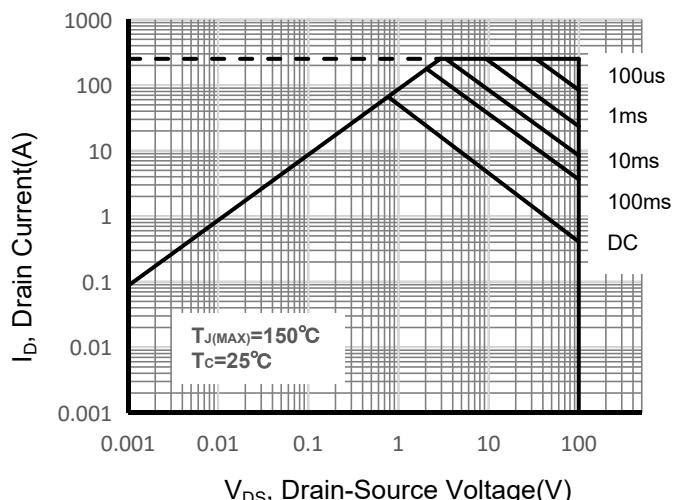


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

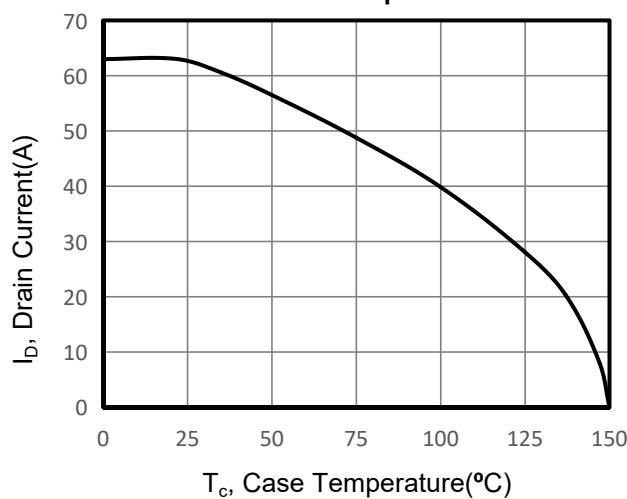
**Figure 7. Drain-Source On-Resistance**



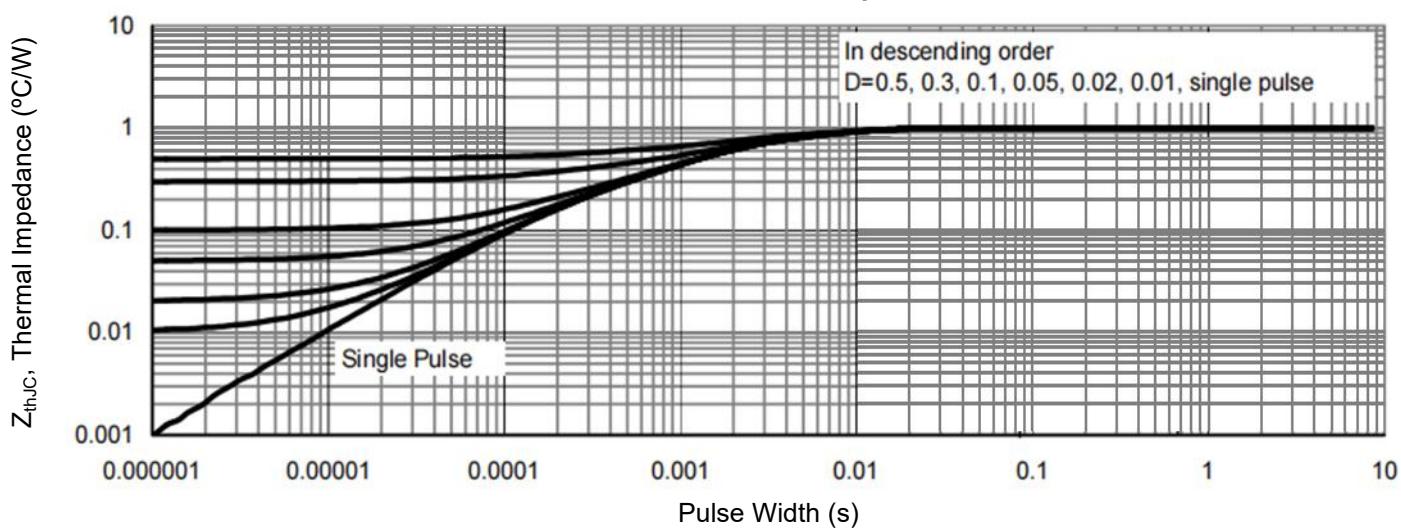
**Figure 8. Safe Operation Area**



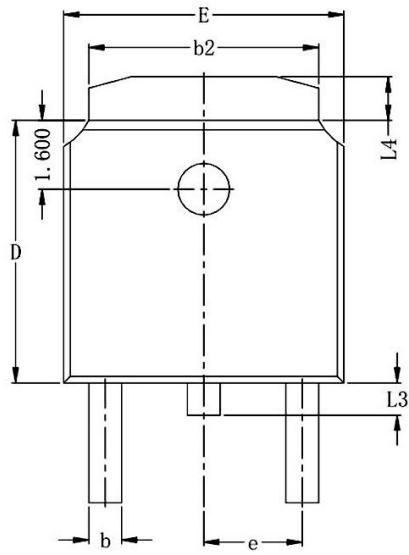
**Figure 9. Maximum Continuous Drain Current vs Case Temperature**



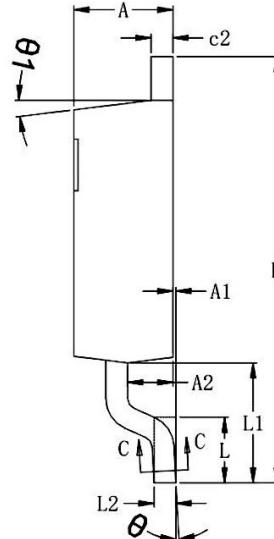
**Figure 10. Normalized Maximum Transient Thermal Impedance**



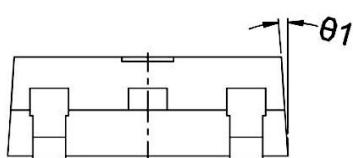
## TO-252 Package Information



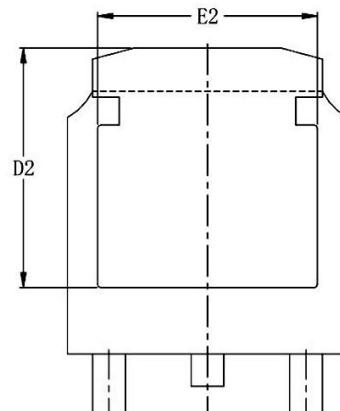
TOP VIEW



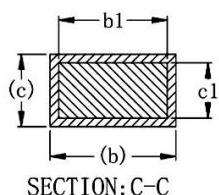
SIDE VIEW (Right)



SIDE VIEW (Front)



BOTTOM VIEW



SECTION: C-C

OPTION 1

| DIM<br>SYMBOL | MIN.  | NOM.  | MAX.  | DIM<br>SYMBOL | MIN.       | NOM.  | MAX.   |
|---------------|-------|-------|-------|---------------|------------|-------|--------|
| A             | 2.200 | 2.300 | 2.400 | E             | 6.400      | 6.500 | 6.600  |
| A1            | 0.000 | 0.070 | 0.130 | E2            | 4.900      | 5.100 | 5.300  |
| A2            | 0.950 | 1.050 | 1.150 | e             | 2.286 BSC. |       |        |
| b             | 0.700 | 0.800 | 0.900 | H             | 9.700      | 9.900 | 10.100 |
| b1            | 0.660 | 0.760 | 0.860 | L             | 1.380      | 1.525 | 1.725  |
| b2            | 5.134 | 5.334 | 5.534 | L1            | 2.588      | 2.788 | 2.988  |
| c             | 0.448 | 0.548 | 0.648 | L2            | 0.508 BSC. |       |        |
| c1            | 0.458 | 0.508 | 0.558 | L3            | 0.600      | 0.750 | 0.950  |
| c2            | 0.448 | 0.548 | 0.648 | L4            | 0.812      | 1.012 | 1.212  |
| D             | 6.000 | 6.100 | 6.200 | θ             | 1°         | 3°    | 5°     |
| D2            | 5.372 | 5.572 | 5.772 | θ1            | 6°         | 7°    | 8°     |